

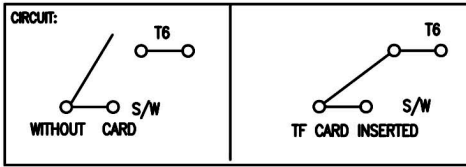
NOTE:

- 一. MATERIAL AND FINISH
 - 1. HOUSING:LCP, UL 94V-0 , COLOR:WHITE
 - 2. CONTACT :COPPER ALLOY
GOLD FLASH PLATING ON CONTACT AREA,
GOLD FLASH PLATING ON SOLDER TAILS
50u" NICKEL UNDER PLATING OVER ALL
 - 3. SHELL :SUS304-3/4H
40u" NICKEL UNDER PLATING OVER ALL

二. MECHANICAL CHARACTERISTICS

- 1. Insertion Force :2.0Kgf Max
 - 2. Withdrawal Force :0.1Kgf Min
 - 3. Durability :5000次
- 三.
- 1. Current rating :1.0A AC/DC
 - 2. Contact resistance :100mΩ MAX
 - 3. Insulation resistance :500MΩ MIN
 - 4. Operating temperature :-20℃~65℃

SIM pin assignment	
	Name
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved



TF CARD PIN ASSIGNMENT	
PIN NO.	PIN ASSIGNMENT
T1	DAT2
T2	CD/DAT3 ²
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DAT0
T8	DAT1

RoHS
Compliant

HSM 玄茂科技股份有限公司
HSUAN MAO TECHNOLOGY CO., LTD.

APPD. 核准	SCALE 比例 参考	TOLERANCE: XX ±0.30 XXX ±0.25 X.XXX ±0.15	PART NAME 品名 MICRO SIM+T-FLASH Card Connector Dual Port 16Pin SMT Type H=2.28mm W/ DIP Foot Gold Flash Plating White Color Reel Packing ROHS
DWG. 製圖 Betty	UNIT 單位 MM	SIZE: 紙張尺寸 A 4	PART NO. 料號 C0660-16DGWRY0R
DATE 制表日 2018/12/19	PAGE 張數 1 OF 1	REV. 版次 A	